



Product description

Polyamide 6

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Unreinforced, toughened, PA6, performance polyamide SenTherm 301-02 HF 1 is a high-performance, high flow thermally conductive resin for injection moulding

Product applications

SenTherm 301-02 HF 1 is a highly flowable injection moulding grade, with consistent thermal conductivity. This grade is suitable for both automotive and LEDS parts offering a cost-effective, low carbon solution for complex shapes.

Product Information

Resin Identification PA6 ISO 1043

Rheological properties¹⁾

Properties	Method	Unit	Typical Value*
Mould shrinkage, parallel ²⁾	ISO 294-4, 2577	%	0.5
Mould shrinkage, transversal ²⁾	ISO 294-4, 2577	%	0.6

Characteristics 1)

Properties	Method	Unit	Typical Value*
Density	ISO 1183	Kg/m³	1360
Melt flow rate 275°C 5kg	ISO1133/T	g/10 min	29.5
Thermal conductivity (Injection moulded)	ASTM D7984	W/mK	1.5
Thermal conductivity (In- plane)	ISO22007	W/mK	5.5
Thermal conductivity (Compression moulded)	ASTM D7984	W/mK	3.0
Tensile modulus (50mm/min)	ISO 527	MPa	2225
Tensile strength (50mm/min)	ISO 527	MPa	58
Strain at break	ISO 527	%	4





Characteristics 1)

Properties	Method	Unit	Typical Value*
Flexural modulus	ISO 178	MPa	4900
Charpy impact (23°C)	ISO 180/1A	kJ/m²	15

Injection 1)

Properties	Unit	Typical Value*
Drying recommended		Yes
Drying temperature	°C	80
Drying time, Dehumidified oven	Hours	4
Process moisture content	%	0.1
Melt temperature	°C	260
Min melt temperature	°C	250
Max melt temperature	°C	270
Min mould temperature	°C	70
Max mould temperature	°C	90
Ejection temperature	°C	190

- 1) The information stated on technical data sheets should be used as indicative only for material selection and not utilised for specifications or part and tool design.
- 2) Measurements have been estimated from moulded laboratory parts; actual shrinkage may be outside these parameters. This is dependant on mould conditions and parameters. Our recommendation is using legacy tooling before cutting on a new moulding tool.

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